

# **BCM**

# **Product Change Notice**

PCN Type: ■Hardwa	are □BIOS/Firmwa	re □Package	e/Label □Drive	r □OS □Others	Page: <u>1</u> of <u>1</u>
PCN Number: 70821-H1-004/		Revision: A		Date of Publication: 04/01/2013	
70822-H1-003/ 71321-H1-005/					
71322-H1-003/ 71323-H1-004					
PRODUCT NAME	PRODUCT PART#	OLD — REV. — NEW		REVISION TYPE	
MX67QMD	70821-C	2.0	2.0*/ 2.1	Hardware	
MX67QMD-LC	70822	1.1	1.2		
MX67QM	71321-C	1.2	1.3		
MX67QMU	71322-C	1.1	1.2		
MX67QM-QC	71323	1.1	1.2		

## REASON OF CHANGE:

1) To prevent lost CMOS due to battery contact disruption from vibration or accidental contact.

#### DESCRIPTION OF CHANGE:

1) \*Apply Acetate cloth tape on work in process and warranty returned goods.



Apply heat shrink tubing on new production.



#### IMPACT OF CHANGE AND RECOMMEND ACTION:

This change has been thoroughly evaluated to ensure that there are no quality, reliability, functional, thermal, driver or UL certification implications to our customers.

BCM is not recommending customers to perform additional qualification of these changes.

AFFECTED BY THIS CHANGE			
Specification	NO		
Packaging	NO		
Labeling	NO		
BIOS	NO		
Driver	NO		
Hardware	YES		

#### **CUT IN DATE:**

Date: 04/01/2013

OR **Lot#**:

\*Cut in date is based on the current forecast.

Parts Disposition	Rework	As Is	Scrap
New Order	Х		
In Process	Χ*		
Finished Goods	Χ*		
RMA	Χ*		

This PCN had been QUALIFIED and APPROVED by BCM Engineering Department on 04/01/2013.

### APPROVED BY

VP OF SALES	<approved></approved>	04/01/2013
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Signature Date

Doc#: F-G0-0-005F